



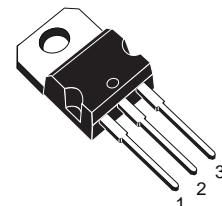
# STGP7NB120SD

N-CHANNEL 7A - 1200V - TO-220

PowerMESH™ IGBT

TYPE	V <sub>CES</sub>	V <sub>CE(sat)</sub>	I <sub>C</sub>
STGP7NB120SD	1200 V	< 2.1 V	7 A

- HIGH INPUT IMPEDANCE (VOLTAGE DRIVEN)
- VERY LOW ON-VOLTAGE DROP ( $V_{cesat}$ )
- OFF LOSSES INCLUDE TAIL CURRENT
- HIGH CURRENT CAPABILITY



TO-220

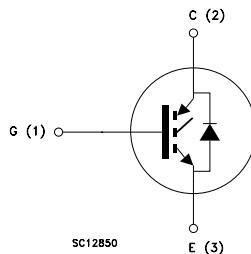
## DESCRIPTION

Using the latest high voltage technology based on a patented strip layout, STMicroelectronics has designed an advanced family of IGBTs, the PowerMESH™ IGBTs, with outstanding performances. The suffix "S" identifies a family optimized achieve minimum on-voltage drop for low frequency applications (<1kHz).

## APPLICATIONS

- MOTOR CONTROL
- LIGHT DIMMER
- INTRUSH CURRENT LIMITATION

## INTERNAL SCHEMATIC DIAGRAM



## ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V <sub>CES</sub>	Collector-Emitter Voltage ( $V_{GS} = 0$ )	1200	V
V <sub>ECR</sub>	Reverse Battery Protection	20	V
V <sub>GE</sub>	Gate-Emitter Voltage	±20	V
I <sub>C</sub>	Collector Current (continuous) at $T_C = 25^\circ\text{C}$	10	A
I <sub>C</sub>	Collector Current (continuous) at $T_C = 100^\circ\text{C}$	7	A
I <sub>CM</sub> (●)	Collector Current (pulsed)	20	A
P <sub>TOT</sub>	Total Dissipation at $T_C = 25^\circ\text{C}$	90	W
	Derating Factor	0.7	W/°C
T <sub>stg</sub>	Storage Temperature	-65 to 150	°C
T <sub>j</sub>	Max. Operating Junction Temperature	150	°C

(●) Pulse width limited by safe operating area

## STGP7NB120SD

### THERMAL DATA

Rthj-case	Thermal Resistance Junction-case Max	1.38	°C/W
Rthj-amb	Thermal Resistance Junction-ambient Max	62.5	°C/W
Rthc-h	Thermal Resistance Case-heatsink Typ	0.5	°C/W

### ELECTRICAL CHARACTERISTICS (T<sub>CASE</sub> = 25 °C UNLESS OTHERWISE SPECIFIED) OFF

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
V <sub>BR</sub> (CES)	Collector-Emitter Breakdown Voltage	I <sub>C</sub> = 250 µA, V <sub>GE</sub> = 0	1200			V
V <sub>BR</sub> (ECR)	Emitter-Collector Breakdown Voltage	I <sub>C</sub> = 10mA, V <sub>GE</sub> = 0	20			V
I <sub>CES</sub>	Collector cut-off (V <sub>GE</sub> = 0)	V <sub>CE</sub> = Max Rating, T <sub>C</sub> = 25 °C V <sub>CE</sub> = Max Rating, T <sub>C</sub> = 125 °C			50 250	µA µA
I <sub>GES</sub>	Gate-Emitter Leakage Current (V <sub>CE</sub> = 0)	V <sub>GE</sub> = ±20V , V <sub>CE</sub> = 0			±100	nA

### ON (1)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
V <sub>GE(th)</sub>	Gate Threshold Voltage	V <sub>CE</sub> = V <sub>GE</sub> , I <sub>C</sub> = 250µA	3		5	V
V <sub>CE(sat)</sub>	Collector-Emitter Saturation Voltage	V <sub>GE</sub> = 15V, I <sub>C</sub> = 3.5 A V <sub>GE</sub> = 15V, I <sub>C</sub> = 7 A V <sub>GE</sub> = 15V, I <sub>C</sub> = 10 A			1.6 2.1	V V V

### DYNAMIC

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
g <sub>fs</sub>	Forward Transconductance	V <sub>CE</sub> = 25 V , I <sub>C</sub> = 7 A	2.5	4.5		S
C <sub>ies</sub> C <sub>oes</sub> C <sub>res</sub>	Input Capacitance Output Capacitance Reverse Transfer Capacitance	V <sub>CE</sub> = 25V, f = 1 MHz, V <sub>GE</sub> = 0		430 40 7		pF pF pF
Q <sub>g</sub>	Gate Charge	V <sub>CE</sub> = 960V, I <sub>C</sub> = 7 A, V <sub>GE</sub> = 15V		29		nC
I <sub>CL</sub>	Latching Current	V <sub>clamp</sub> = 960V , T <sub>j</sub> = 150°C R <sub>G</sub> = 1KΩ	10			A

### SWITCHING ON

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
t <sub>d(on)</sub> t <sub>r</sub>	Turn-on Delay Time Rise Time	V <sub>CC</sub> = 960 V, I <sub>C</sub> = 7 A R <sub>G</sub> = 1KΩ , V <sub>GE</sub> = 15 V		570 270		ns ns
(di/dt) <sub>on</sub> E <sub>on</sub>	Turn-on Current Slope Turn-on Switching Losses	V <sub>CC</sub> = 960 V, I <sub>C</sub> = 7 A, R <sub>G</sub> =1KΩ V <sub>GE</sub> = 15 V, T <sub>j</sub> = 125°C		800 3.2		A/µs mJ

**ELECTRICAL CHARACTERISTICS (CONTINUED)****SWITCHING OFF**

<b>Symbol</b>	<b>Parameter</b>	<b>Test Conditions</b>	<b>Min.</b>	<b>Typ.</b>	<b>Max.</b>	<b>Unit</b>
$t_c$	Cross-over Time	$V_{cc} = 960 \text{ V}$ , $I_C = 7 \text{ A}$ ,		4.9		$\mu\text{s}$
$t_r(V_{off})$	Off Voltage Rise Time	$R_{GE} = 1\text{K}\Omega$ , $V_{GE} = 15 \text{ V}$		2.9		$\mu\text{s}$
$t_f$	Fall Time			3.3		$\mu\text{s}$
$E_{off}(**)$	Turn-off Switching Loss			15		$\text{mJ}$
$t_c$	Cross-over Time	$V_{cc} = 960 \text{ V}$ , $I_C = 7 \text{ A}$ ,		7.5		$\mu\text{s}$
$t_r(V_{off})$	Off Voltage Rise Time	$R_{GE} = 1\text{K}\Omega$ , $V_{GE} = 15 \text{ V}$		5.5		$\mu\text{s}$
$t_f$	Fall Time	$T_j = 125 \text{ }^{\circ}\text{C}$		6.2		$\mu\text{s}$
$E_{off}(**)$	Turn-off Switching Loss			22		$\text{mJ}$

**COLLECTOR-EMITTER DIODE**

<b>Symbol</b>	<b>Parameter</b>	<b>Test Conditions</b>	<b>Min.</b>	<b>Typ.</b>	<b>Max.</b>	<b>Unit</b>
$I_f$	Forward Current				3.5	A
$I_{fm}$	Forward Current pulsed				28	A
$V_f$	Forward On-Voltage	$I_f = 3.5 \text{ A}$ $I_f = 3.5 \text{ A}, T_j = 125 \text{ }^{\circ}\text{C}$		1.7 1.5	2.0	V V
$t_{rr}$	Reverse Recovery Time	$I_f = 3.5 \text{ A}, V_R = 600 \text{ V}$ ,		190		ns
$Q_{rr}$	Reverse Recovery Charge	$T_j = 125 \text{ }^{\circ}\text{C}$ , $di/dt = 100\text{A}/\mu\text{s}$		850		nC
$I_{rrm}$	Reverse Recovery Current			9		A

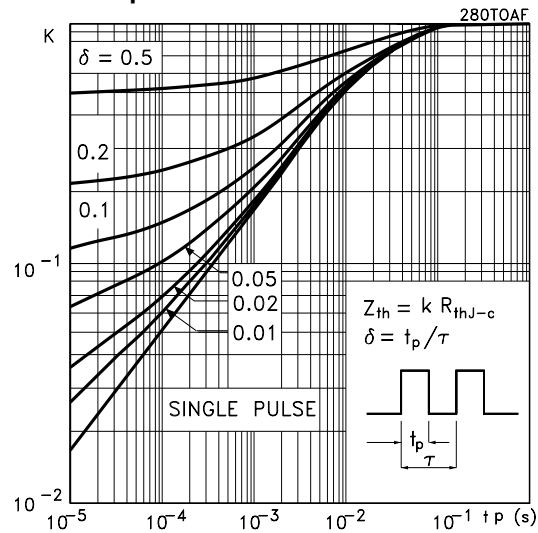
Note: 1. Pulsed: Pulse duration = 300  $\mu\text{s}$ , duty cycle 1.5 %.

2. Pulse width limited by max. junction temperature.

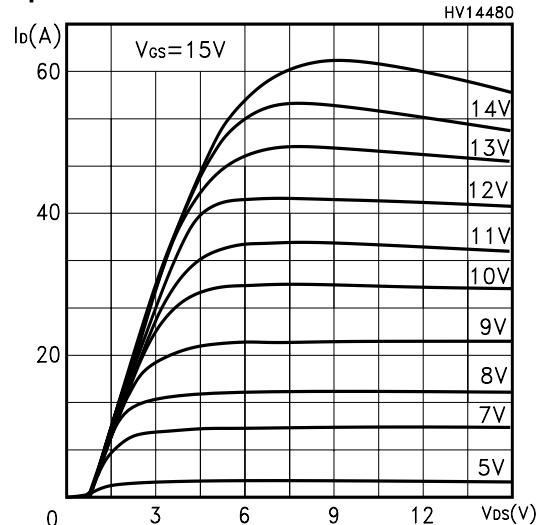
(\*\*)Losses include Also the Tail (Jedec Standardization)

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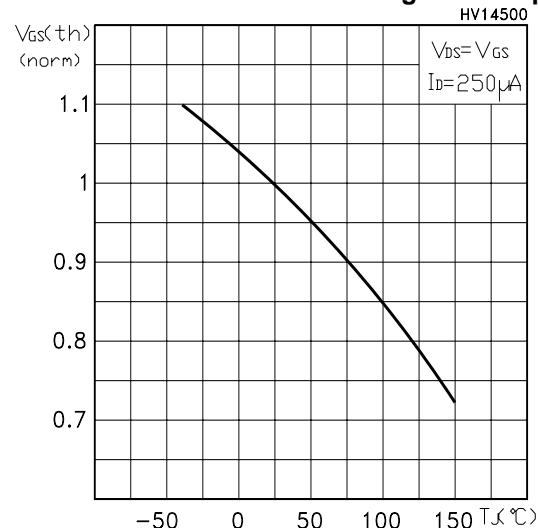
### Thermal Impedance



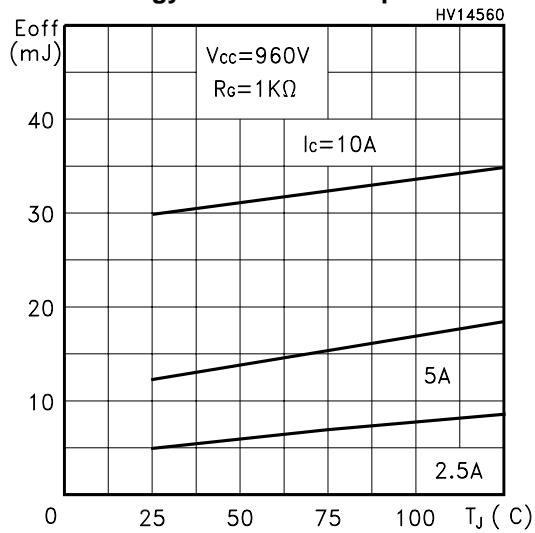
### Output Characteristics



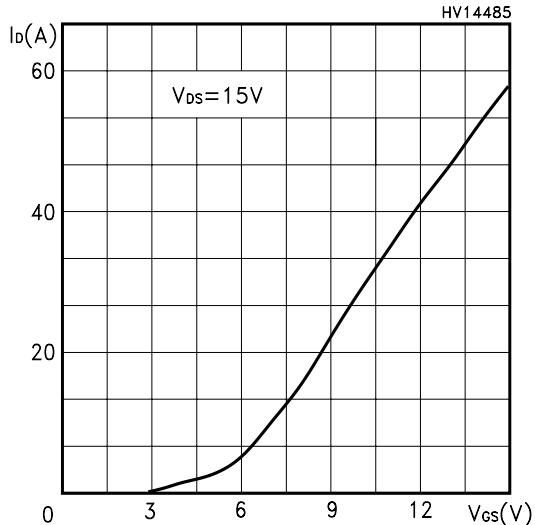
### Normalized Gate Threshold Voltage vs Temp.



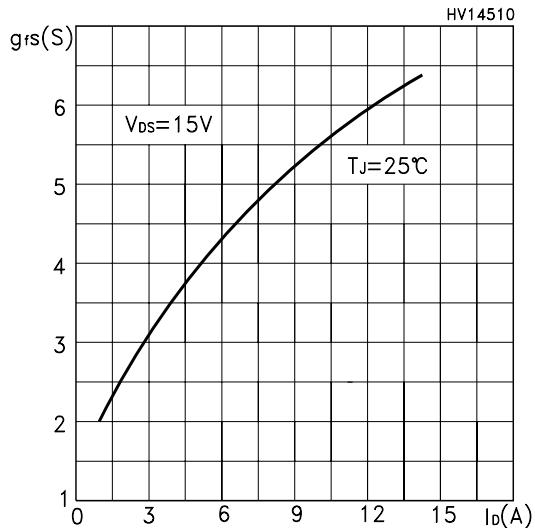
### Turn-Off Energy Losses vs Temperature



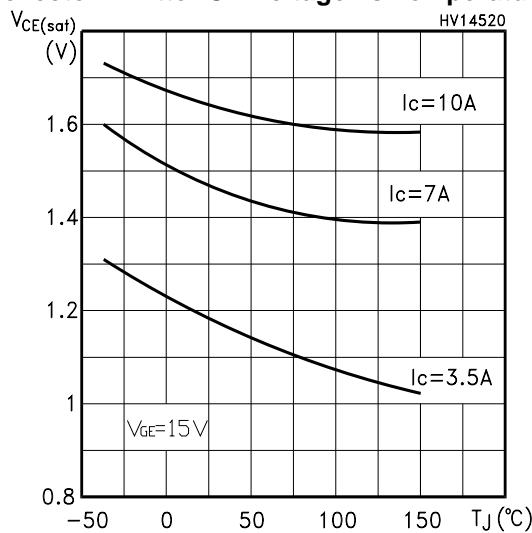
### Transfer Characteristics



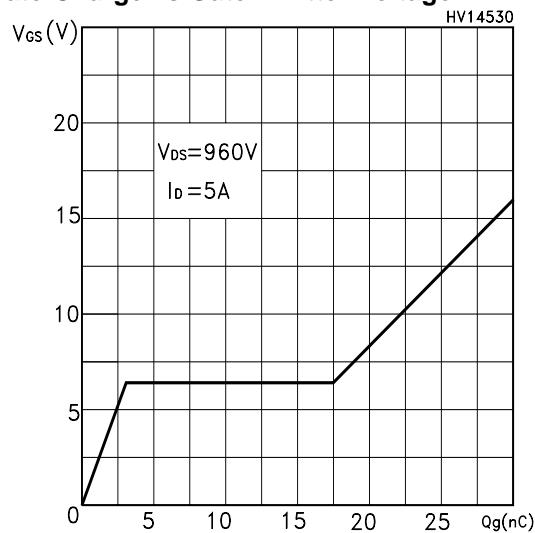
### Transconductance



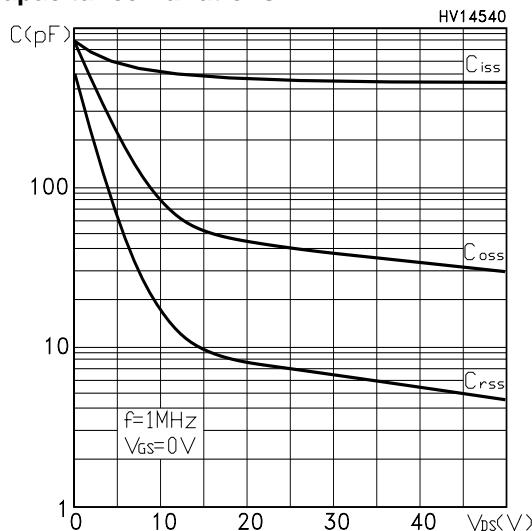
**Collector-Emitter On Voltage vs Temperature**



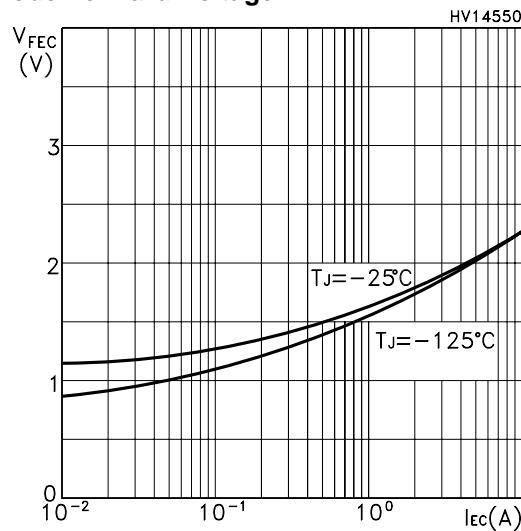
**Gate-Charge vs Gate-Emitter Voltage**



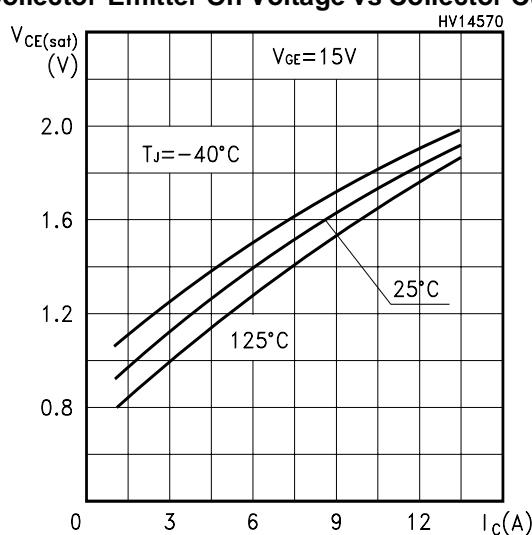
**Capacitance Variations**



**Diode Forward Voltage**

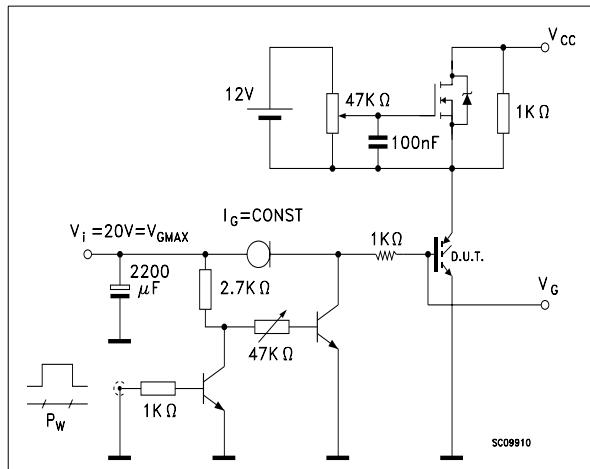


**Collector-Emitter On Voltage vs Collector Current**

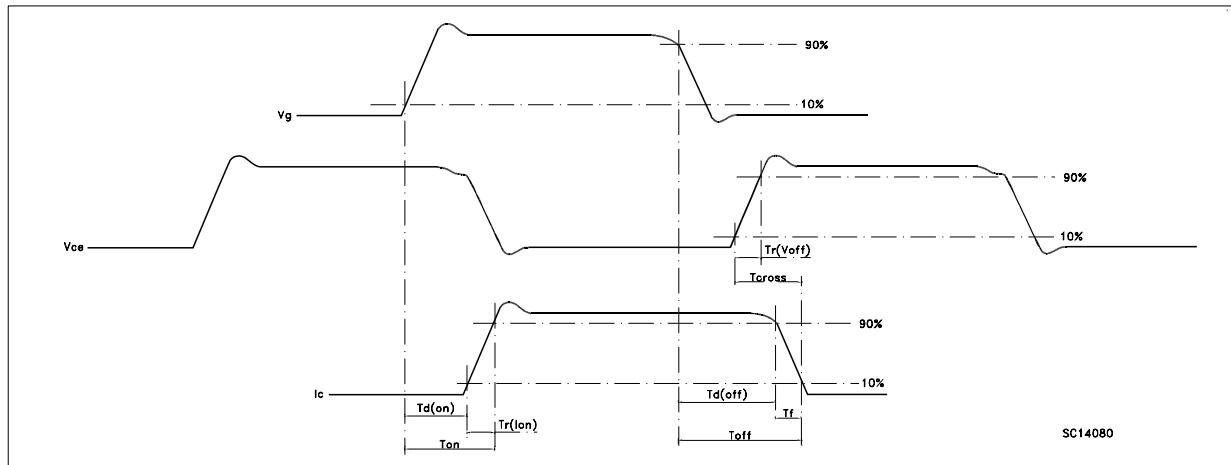
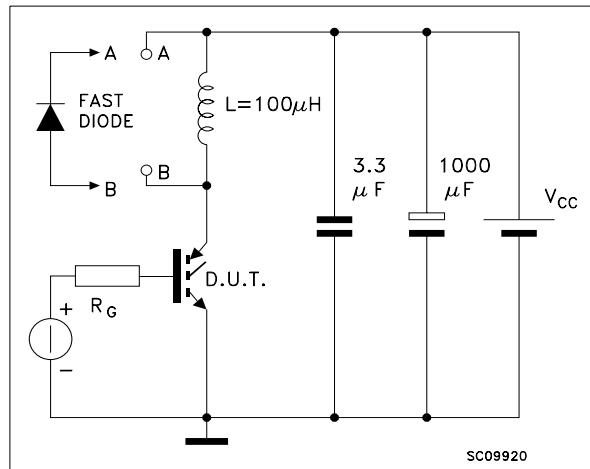


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**Fig. 1:** Gate Charge test Circuit

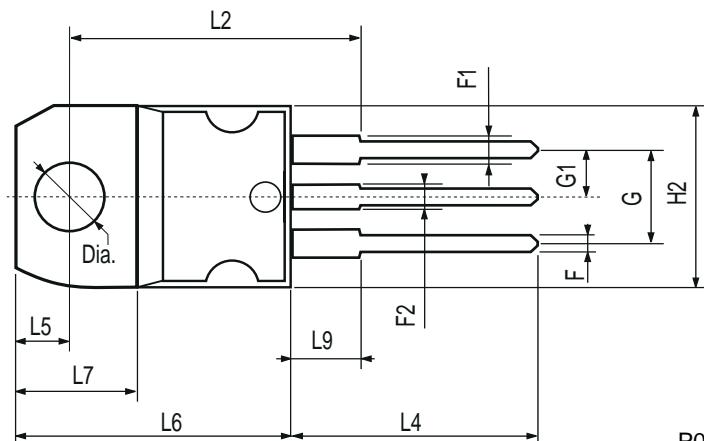
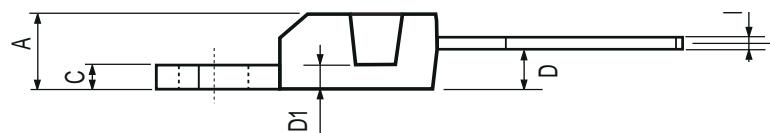


**Fig. 2:** Test Circuit For Inductive Load Switching



## TO-220 MECHANICAL DATA

DIM.	mm			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A	4.40		4.60	0.173		0.181
C	1.23		1.32	0.048		0.051
D	2.40		2.72	0.094		0.107
D1		1.27			0.050	
E	0.49		0.70	0.019		0.027
F	0.61		0.88	0.024		0.034
F1	1.14		1.70	0.044		0.067
F2	1.14		1.70	0.044		0.067
G	4.95		5.15	0.194		0.203
G1	2.4		2.7	0.094		0.106
H2	10.0		10.40	0.393		0.409
L2		16.4			0.645	
L4	13.0		14.0	0.511		0.551
L5	2.65		2.95	0.104		0.116
L6	15.25		15.75	0.600		0.620
L7	6.2		6.6	0.244		0.260
L9	3.5		3.93	0.137		0.154
DIA.	3.75		3.85	0.147		0.151



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